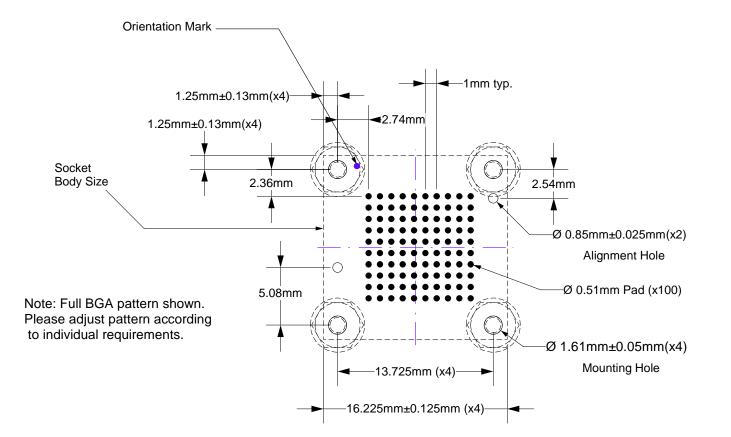


SG-BGA-6213 Drawing	Status: Released	Scale:	-	Rev: B	All
© 2006 IRONWOOD ELECTRONICS, INC. 11351 Rupp Drive, Suite 400, Burnsville, MN 55337	Drawing: J. Glab		Date: 12/14/06		are
Tele: (952) 229-8200 www.ironwoodelectronics.com	File: SG-BGA-6213 Dwg.mcd		Modified: 7/7/09, AE		

All tolerances: ± 0.125 mm (unless stated otherwise). Materials and specifications are subject to change without notice.

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Target PCB Recommendations Total thickness: 1.6mm min. Plating: Gold or Solder finish PCB Pad height: Same or higher than solder mask

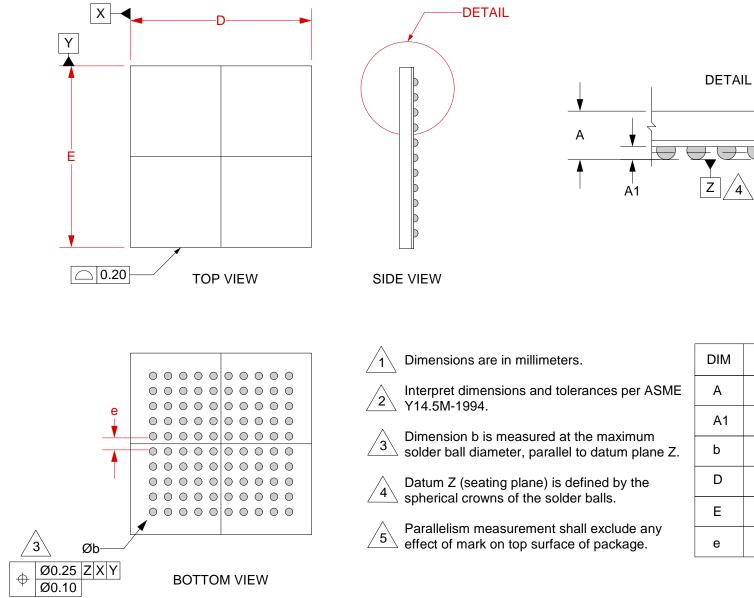
NOTE: Steel backing plate may be required based on end user's application

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.

SG-BGA-6213 Drawing		Status: Released	Scale:	3:1	Rev: B
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	()	File: SG-BGA-6213 Dwg.mcd		Modified: 7/7/09, AE	

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Compatible BGA Spec



DIM	MIN	MAX		
A		1.7		
A1	0.25	0.45		
b		0.7		
D	11.00 BSC			
E	11.00 BSC			
е	1.00 BSC			

<u>_5</u> 0.20 Z

☐ 0.12 Z

	SG-BGA-6213 Drawing	Status: Released	Scale	: -	Rev: B
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	Tele: (952) 229-8200	File: SG-BGA-6213 Dwg.mcd		Modified: 7/7/09, AE	

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Array 10x10